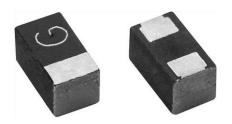
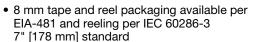


Solid Tantalum Chip Capacitors MICROTAN® Low ESR, Leadframeless Molded



FEATURES

- Lead (Pb)-free face-down terminations
- · Mounting: Surface mount





- Low ESR
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

PERFORMANCE CHARACTERISTICS

Operating Temperature: - 55 °C to + 125 °C (above 85 °C, voltage derating is required)

Capacitance Range: 1 µF to 220 µF

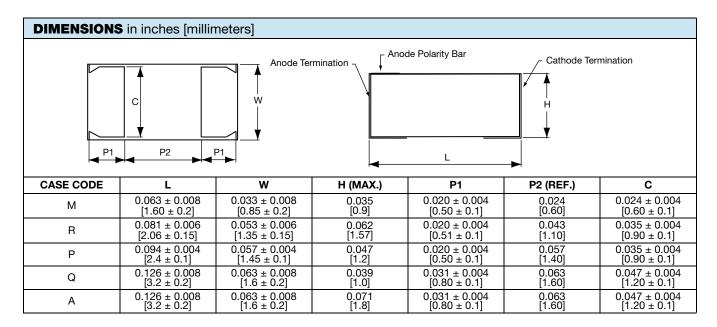
Capacitance Tolerance: ± 20 % standard, ± 10 % available

Voltage Range: 4 V_{DC} to 16 V_{DC}

ORDERING INFORMATION							
TR8	М	106	М	6R3	С	2000	
TYPE	CASE CODE	CAPACITANCE	CAPACITANCE TOLERANCE	DC VOLTAGE RATING AT + 85 °C	TERMINATION	ESR	
	See Ratings and Case Codes table	This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow.	K = ± 10 % M = ± 20 %	This is expressed in volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V).	C = 100 % tin 7" [178 mm] reel A = Gold/7" [178 mm] reel	Maximum 100 kHz ESR in (mΩ) See note below.	

Note

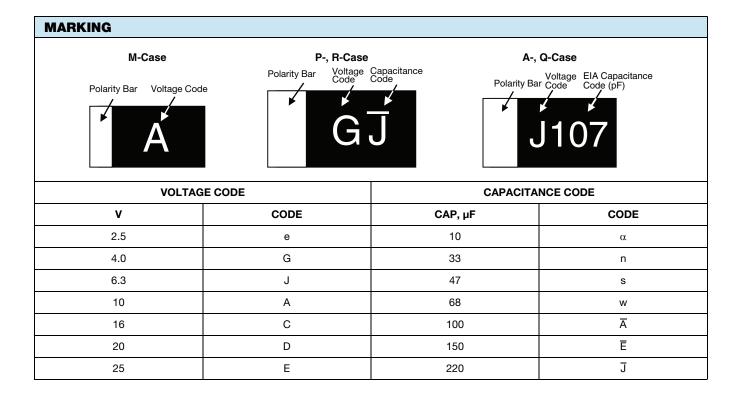
We reserve the right to supply higher voltage ratings and tighter capacitance tolerance capacitors in the same case size.
 Voltage substitutions will be marked with the higher voltage rating.
 Low ESR solid tantalum chip capacitors allow delta ESR of 1.25 times the datasheet limit after mounting.





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RATINGS AN	RATINGS AND CASE CODES					
μF	2.5 V	4 V	6.3 V	10 V	16 V	25 V
1.0					М	
2.2				М	М	
4.7				М	М	
10			М	М	R	А
15			М	М		
22			М			
33		М	М	Р		
47		М		Р		
100		Р	P/A			
220	Р	P/Q				







CAPACITANCE (μF)	CASE CODE	PART NUMBER	MAX. DCL AT + 25 °C (μA)	MAX. DF AT + 25 °C (%)	MAX. ESR AT + 25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I _{RMS} (A)
		2.5 V _{DC} AT	+ 85 °C; 1.6 V _{DC}	AT + 125 °C		
220	Р	TR8P227M2R5C1500	11.0	30	1.50	0.129
		4 V _{DC} AT -	+ 85 °C; 2.7 V _{DC} A	T + 125 °C		
33	М	TR8M336M004C1500	2.6	30	1.50	0.129
47	М	TR8M476M004C1500	3.8	40	1.50	0.129
100	Р	TR8P107M004C1500	4.0	30	1.50	0.173
220	Р	TR8P227(1)004C1000	17.6	30	1.00	0.212
220	Q	TR8Q227M004C1200	88.0	80	1.20	0.214
		6.3 V _{DC} A	Γ + 85 °C; 4 V _{DC} A	T + 125 °C		
10	М	TR8M106(1)6R3C2000	0.6	8	2.00	0.112
15	М	TR8M156M6R3C3000	0.9	20	3.00	0.091
22	М	TR8M226M6R3C1500	2.8	20	1.50	0.129
33	М	TR8M336M6R3C1500	4.2	30	1.50	0.129
100	Р	TR8P107M6R3C1500	6.3	30	1.50	0.173
100	Α	TR8A107M6R3C0500	6.3	20	0.50	0.390
		10 V _{DC} AT	T + 85 °C; 7 V _{DC} A	T + 125 °C		
2.2	М	TR8M225M010C4000	0.5	10	4.00	0.079
4.7	М	TR8M475M010C3000	0.5	6	3.00	0.079
10	М	TR8M106M010C2000	1.0	20	2.00	0.112
15	М	TR8M156(1)010C3000	1.5	30	3.00	0.091
33	Р	TR8P336M010C2500	3.3	20	2.50	0.134
47	Р	TR8P476M010C0800	4.7	22	0.80	0.237
47	Р	TR8P476M010C1000	4.7	22	1.00	0.212
		16 V _{DC} AT	+ 85 °C; 10 V _{DC} A	T + 125 °C		
1.0	М	TR8M105(1)016C9500	0.5	6	9.50	0.050
2.2	М	TR8M225M016C4000	0.5	10	4.00	0.079
4.7	М	TR8M475M016C4000	0.8	8	4.00	0.079
4.7	М	TR8M475M016C9000	0.8	8	9.00	0.053
10	R	TR8R106M016C5000	1.6	8	5.00	0.095
		25 V _{DC} AT	+ 85 °C; 17 V _{DC} A	T + 125 °C		
10	Α	TR8A106M025C2500	2.5	10	2.50	0.173

Note

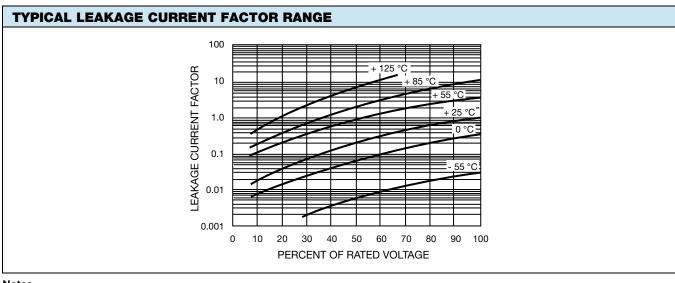
[•] Part number definition:

⁽¹⁾ Tolerance: For 10 % tolerance, specify "K"; for 20 % tolerance, change to "M"



CAPACITORS PERFORMANCE CHARACTERISTICS

ELECTRICAL PERFORM	MANCE CHARACTER	RISTICS			
ITEM	PERFORMANCE CHARACTERISTICS				
Category Temperature Range	- 55 °C to + 85 °C (to + 1	25 °C with voltage deratir	ng)		
Capacitance Tolerance	± 20 %, ± 10 %, tested v	via bridge method, at 25 °C	C, 120 Hz		
Dissipation Factor (at 120 Hz)	Limits per Standard Ratir	ngs table. Tested via bridg	ge method, at 25 °C, 120 H	Z.	
ESR (100 kHz)	Limits per Standard Ratir	ngs table. Tested via bridg	ge method, at 25 °C, 100 kl	·lz.	
Leakage Current	1 kΩ resistor in series with in Standard Ratings table	h the capacitor under test,	tors for 5 min using a stead leakage current at 25 °C is urrent varies with temperate ctor.	not more than described	
Reverse Voltage	Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC rating at + 25 °C 5 % of the DC rating at + 85 °C 1 % of the DC rating at + 125 °C Vishay does not recommend intentional or repetitive application of reverse voltage				
Temperature Derating	If capacitors are to be used at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors: 1.0 at + 25 °C 0.9 at + 85 °C 0.4 at + 125 °C				
	+ 85 °C F	RATING	+ 125 °C RATING		
	RATED VOLTAGE (V)	SURGE VOLTAGE (V)	RATED VOLTAGE (V)	SURGE VOLTAGE (V)	
	2.5	3.3	1.7	2.2	
	4.0	5.2	2.7	3.4	
	6.3	8.0	4.0	5.0	
Operating Temperature	10	13	7.0	8.0	
	16	20	10	12	
	20	26	13	16	
	25	32	17	20	
	35	46	23	28	
	50	65	33	40	



Notes

- At + 25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table.
- At + 85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table.
- At + 125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table.

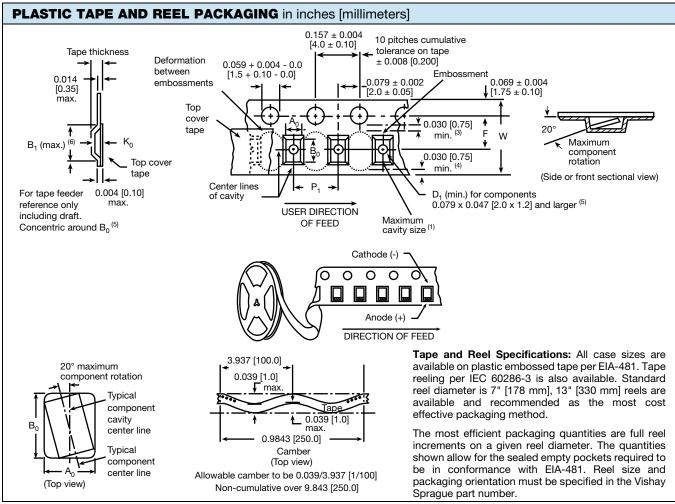


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ENVIRONMENT	ENVIRONMENTAL PERFORMANCE CHARACTERISTICS						
ITEM	CONDITION	POST TEST PERFORMANCE					
Life Test at + 85 °C	1000 h application of rated voltage at 85 °C with a 3 Ω series resistance, MIL-STD-202 method 108A	Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial					
Humidity Test	At 40 °C/90 % RH 500 h, no voltage applied. MIL-STD-202 method 103B	Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial					
Thermal Shock	At - 55 °C/+ 125 °C, 30 min each, for 5 cycles. MIL-STD-202 method 107G	Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial					

ITEM	CONDITION	POST TEST PERFORMANCE		
Apply a pressure load of 5 N for 10 s ± 1 s horizontally to the center of capacitor side body. AEC Q-200 rev. C method 006		There shall be no visual damage when viewed at 20 x magnification and the component shall meet the original electrical requirements.		
Vibration	MIL-STD-202, method 204D, 10 Hz to 2000 Hz, 20 <i>g</i> peak	Capacitance change ± 10 % Dissipation factor Initial specified value or less Leakage current Initial specified value or less ESR Initial specified value or less There shall be no mechanical or visual damage to capacitors post-conditioning.		
Shock	MIL-STD-202, method 213B, condition I, 100 g peak	Capacitance change ± 10 % Dissipation factor Initial specified value or less Leakage current Initial specified value or less ESR Initial specified value or less There shall be no mechanical or visual damage to capacitors		
Resistance to Solder Heat	MIL-STD-202, method 210F, condition K	post-conditioning. Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial There shall be no mechanical or visual damage to capacitors post-conditioning.		
Solderability	MIL-STD-202, method 208H, ANSI/J-STD-002, Test B. Applies only to solder and tin plated terminations. Does not apply to gold terminations.	All terminations shall exhibit a continuous solder coating free from defects for a minimum of 95 % of the critical area of any individual lead.		
Resistance to Solvents	MIL-STD-202, method 215D	Marking has to remain legible, no degradation of encapsulation material.		
Flammability	Encapsulation materials meet UL 94 V-0 with an oxygen index of 32 %			



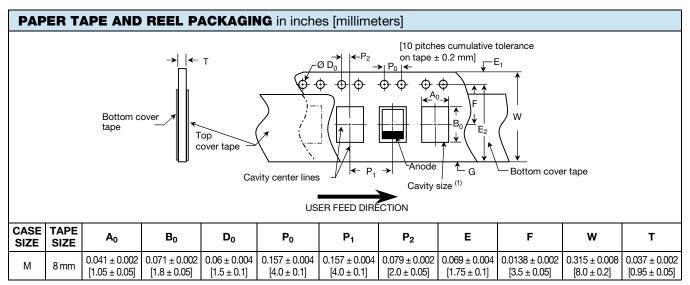


Notes

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only.
- (1) A₀, B₀, K₀, are determined by the maximum dimensions to the ends of the terminals extending from the component body and/or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀, K₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum.
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less.
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less.
- (5) The embossed hole location shall be measured from the sprocket hole controlling the location of the embossement. Dimensions of embossement location shall be applied independent of each other.
- (6) B₁ dimension is a reference dimension tape feeder clearance only.

CARRIE	CARRIER TAPE DIMENSIONS in inches [millimeters]						
CASE CODE	TAPE SIZE	B ₁ (MAX.)	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	w
P, R	8 mm	0.108 [2.75]	0.039 [1.0]	0.138 ± 0.002 [3.5 ± 0.05]	0.054 [1.37]	0.157 ± 0.004 [4.0 ± 1.0]	0.315 + 0.0118/- 0.0039 [8.0 + 0.30/- 0.10]
Q, A	8 mm	0.165 [4.2]	0.039 [1.0]	0.138 ± 0.002 [3.5 ± 0.05]	0.094 [2.4]	0.157 ± 0.004 [4.0 ± 1.0]	0.315 ± 0.012 [8.0 ± 0.30]





Note

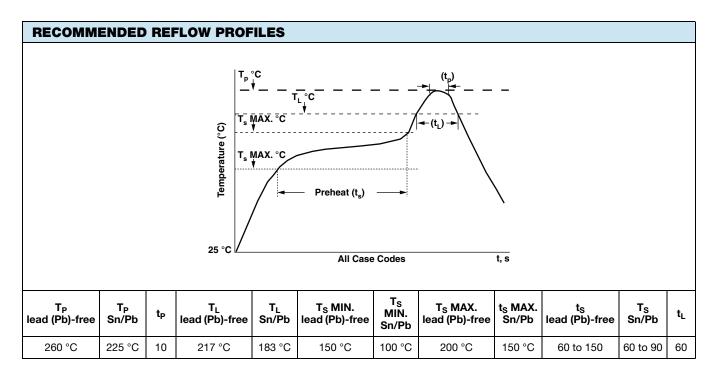
⁽¹⁾ A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and/or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.

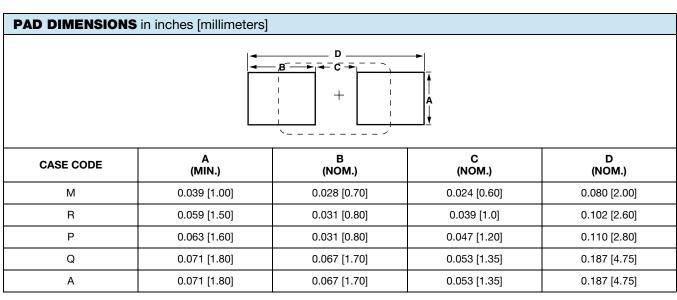
STANDARD PACKAGING QUANTITY				
CASE CODE	QUANTITY (PCS/REEL)			
CASE CODE	7" REEL			
M	4000			
R	2500			
Р	3000			
Q	2500			
A	2000			

RECOMMENDED VOLTAGE DERATING GUIDELINES						
STANDARD CONDITIONS. FOR EXAMPLE: OUTPUT FILTERS						
Capacitor Voltage Rating	Operating Voltage					
4.0	2.5					
6.3	3.6					
10	6.0					
16	10					
20	12					
25	15					
35	24					
50	28					
SEVERE CONDITIONS. FOR EXAMPLE: INPUT FILTERS						
Capacitor Voltage Rating	Operating Voltage					
4.0	2.5					
6.3	3.3					
10	5.0					
16	8.0					
20	10					
25	12					
35	15					
50	24					



POWER DISSIPATION						
CASE CODE	MAXIMUM PERMISSIBLE POWER DISSIPATION AT + 25 °C (W) IN FREE AIR					
М	0.025					
R	0.045					
Р	0.045					
Q	0.055					
А	0.075					









GUIDE TO APPLICATION

 AC Ripple Current: The maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = Power dissipation in watts at + 25 °C (see paragraph number 5 and the table Power Dissipation)

R_{ESR} = The capacitor equivalent series resistance at the specified frequency

 AC Ripple Voltage: The maximum allowable ripple voltage shall be determined from the formula:

$$V_{\text{RMS}} \, = \, Z \sqrt{\frac{P}{R_{\text{ESR}}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

P = Power dissipation in watts at + 25 °C (see paragraph number 5 and the table Power Dissipation)

R_{ESR} = The capacitor equivalent series resistance at the specified frequency

Z = The capacitor impedance at the specified frequency

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at
- 3. **Reverse Voltage:** These capacitors are capable of withstanding peak voltages in the reverse direction equal to 10 % of the DC rating at + 25 °C, 5 % of the DC rating at + 85 °C and 1 % of the DC rating at + 125 °C
- 4. Temperature Derating: If these capacitors are to be operated at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors as shown:

TEMPERATURE	DERATING FACTOR
+ 25 °C	1.0
+ 85 °C	0.9
+ 125 °C	0.4

5. Power Dissipation: Power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{RMS} value be established when calculating permissible operating levels. (Power Dissipation calculated using + 25 °C temperature rise.)

- 6. **Printed Circuit Board Materials:** Molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelanized steel).
- 7. Attachment:
- 7.1 **Solder Paste:** The recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.
- 7.2 **Soldering:** Capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering and hot plate methods. The Soldering Profile charts show recommended time/temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 2 °C per s. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor.
- 7.2.1 Backward and Forward Compatibility: Capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.
- 8. Cleaning (Flux Removal) After Soldering: Molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chlorethane, Terpene and aqueous cleaning media. However, CFC/ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.
- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. Do not exceed 9W/l at 40 kHz for 2 min.
- 9. Recommended Mounting Pad Geometries: Proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and/or circuit board design.

PRODUCT INFORMATION				
Micro Guide	www.vishay.com/doc?40115			
Moisture Sensitivity	www.vishay.com/doc?40135			
SELECTOR GUIDES				
Solid Tantalum Selector Guide	www.vishay.com/doc?49053			
Solid Tantalum Chip Capacitors	www.vishay.com/doc?40091			
FAQ				
Frequently Asked Questions	www.vishay.com/doc?40110			



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Revision: 02-Oct-12 Document Number: 91000



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